

General Description

IRF740 the silicon N-channel Enhanced VDMOSFETs, is obtained by the self-aligned planar Technology which reduce the conduction loss, improve switching performance and enhance the avalanche energy. The transistor can be used in various power switching circuit for system miniaturization and higher efficiency.

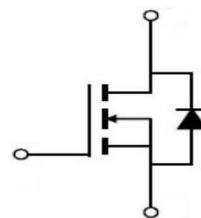
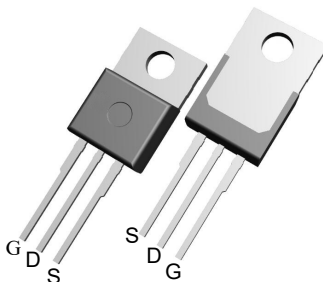


Features

V_{DSS}	450	V
I_D	10	A
$P_D(T_C=25^{\circ}C)$	135	W
$R_{DS(ON)}(at V_{GS}=10V)$	0.53	Ω

Application

- Battery protection
- Load switch
- Uninterruptible power supply



Package Marking and Ordering Information

Product ID	Pack	Marking	Qty(PCS)
IRF740	TO-220	IRF740	1000

Absolute Maximum Ratings ($T_C=25^{\circ}C$ unless otherwise noted)

Symbol	Parameters	Ratings	Unit
V_{DSS}	Drain-Source Voltage	450	V
V_{GS}	Gate-Source Voltage-Continuous	± 30	V
I_D	Drain Current-Continuous (Note 2)	10	A
I_{DM}	Drain Current-Single Pulsed (Note 1)	40	A
P_D	Power Dissipation (Note 2)	135	W
T_j	Max.Operating junction temperature	150	$^{\circ}C$

Electrical Characteristics at $T_J=25\text{ }^{\circ}\text{C}$ unless otherwise specified

Symbo	Parameters	Min	Typ	Max	Units	Conditions
Static Characteristics						
B_{VDSS}	Drain-Source Breakdown VoltageCurrent (Note 1)	450	--	--	V	$I_D=250\mu\text{A}$, $V_{GS}=0\text{V}$, $T_J=25^{\circ}\text{C}$
$V_{GS(th)}$	Gate Threshold Voltage	2.0	--	4.0	V	$V_{DS}=V_{GS}$, $I_D=250\mu\text{A}$
$R_{DS(on)}$	Drain-Source On-Resistance	--	0.48	0.53	Ω	$V_{GS}=10\text{V}$, $I_D=1\text{A}$
I_{GSS}	Gate-Body Leakage Current	--	--	± 100	nA	$V_{GS}=\pm 30\text{V}$, $V_{DS}=0$
I_{DSS}	Zero Gate Voltage Drain Current	--	--	1	μA	$V_{DS}=400\text{V}$, $V_{GS}=0$
gfs	Forward Transconductance	5.8	--	--	S	$V_{DS}=15\text{V}$, $I_D=5\text{A}$

Switching Characteristics						
T _{d (on)}	Turn-On Delay Time	--	17	--	ns	V _{DS} =250V, I _D =10A, R _G =25Ω （Note 2）
T _r	Rise Time	--	10	--	ns	
T _{d (off)}	Turn-Off Delay Time	--	10	--	ns	
T _f	Fall Time	--	10	--	ns	
Q _g	Total Gate Charge	--	35	50	nC	V _{DS} =400V V _{GS} =10V, I _D =10A （Note 2）
Q _{gs}	Gate-Source Charge	--	11	--	nC	
Q _{gd}	Gate-Drain Charge	--	12	--	nC	
Dynamic Characteristics						
C _{iss}	Input Capacitance	--	750	--	pF	V _{DS} =25V, V _{GS} =0, f=1MHz
C _{oss}	Output Capacitance	--	220	--	pF	
C _{rss}	Reverse Transfer Capacitance	--	27	--	pF	
I _S	Continuous Drain-Source Diode Forward Current （Note 2）	--	--	10	A	
V _{SD}	Diode Forward On-Voltage	--	--	1.4	V	I _S =5A, V _{GS} =0
R _{th(j-c)}	Thermal Resistance, Junction to Case	--	--	0.93	°C/W	

Note 1: Repetitive Rating : Pulse width limited by maximum junction temperature

Note 2: Pulse test: $PW \leq 300\mu s$, duty cycle $\leq 2\%$.